

RSM

01 Objective

02

Salient Features

03 Incentives

04 Annexure

Objective



Component ecosystem

To develop robust component manufacturing ecosystem

Offers significant benefits, including

- increased domestic value addition,
- integration with global value chains,
- job creation.

Stronger Economy

Investment

To attract investments (global/domestic) across the value chain by

Integration of domestic electronic industry with the Global Value Chains (GVCs).

Global Competitive Advantage

Technological Capability

Aims to help Indian companies become key players in global electronics markets.

The scheme is a step towards enhancing electronics production in India.

Boost Electronics Production

Salient Features



Scheme aim

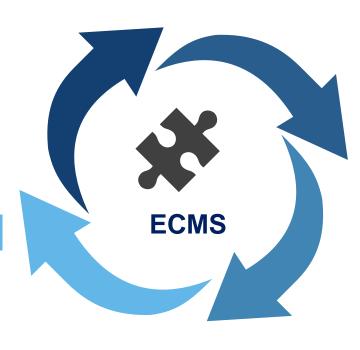
The scheme provides differentiated incentives to Indian manufacturers tailored to overcome specific disabilities for various categories of components and sub-assemblies so that they can acquire technological capabilities and achieve economies of scale.



Turnover Linked Incentive:

- Six (6) years with one (1) year of gestation period
- Capex Incentive: Five (5) years

There shall also be a provision for one (1) year of gestation period on optional basis.



Target Segment

The Target Segment Category under Scheme includes

- Sub-assemblies
- Bare components
- Selected bare components
- Supply chain ecosystem and Capital equipment.

Types of Incentive

The scheme provides differentiated fiscal incentive on target segment products in terms of turnover

- a) Turnover linked incentive
- b) Capex incentive and
- c) Hybrid incentive [i.e. combination of both (a) and (b)]
- d) Employment linked incentive:

A part of turnover linked incentive and capex incentive is linked with employment

Incentives – Type and Quantum

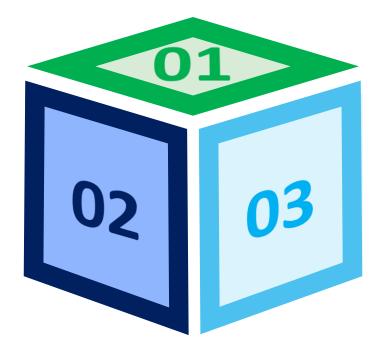


TURNOVER LINKED INCENTIVE

Incentive as a percentage of incremental turnover/ sales over base year as per rate of incentive given in Annexure A(II) for various target segments and products covered therein.

CAPEX INCENTIVE

Incentive on eligible capital expenditure for manufacturing of target segment goods as per rate of incentive given in Annexure A(II) for various target segments and products covered therein.



Category	<u>Target segments</u>	
1	A. Sub-assemblies B. Bare components	
2	C. Selected bare components	
3	D. Supply chain ecosystem and capital equipment for electronics manufacturing	

HYBRID INCENTIVE

Capex incentive for manufacturing of target segment goods as per rate of incentive given in Annexure A(II) for various target segments and products covered therein.

Incentives – Basis and Tenure





Turnover linked incentive

- Shall be given on net incremental sales (over the base year) of target segment goods manufactured in Bharat.
- For disbursement, the incremental sales and cumulative incremental investment shall be mandatory criteria
- Out of total agreed rate, 1% shall be disbursed only on meeting cumulative incremental employment threshold criteria
- In case, unable to meet cumulative incremental employment threshold, incentive shall be given by deducting equivalent to 1% of the turnover from the specified rate



Capex incentive

- Shall be given on eligible capital expenditure, as per rates, incurred for manufacturing of target segment products in Bharat.
- For disbursement, meeting the investment threshold and commencement of commercial production shall be mandatory criteria.
- Out of total rate (25%), 5% of the capex shall be disbursed only on meeting cumulative incremental employment threshold
- In case, unable to meet cumulative incremental employment threshold, incentive shall be given by deducting 5% of the capex from the specified rate



Tenure of the scheme

- Turnover linked incentive: Incentives for a period of six (6) years with a provision for one (1) year of gestation period on optional basis.
- Target segments (A to C): Shall be open for applications for a period of three (3) months initially from 1st May 2025, which may be extended.
- Target segments (D): Shall be open for applications initially for a period of two (2) years from 1st May 2025.
- Turnover linked: first year for the purpose of incremental sales would be counted from 1 April 25 to 31 March 26 (opting for gestation period, date to be read as 1sApril 2026).

Incentives – Eligibility



- Greenfield as well as brownfield investment for the target segment shall be eligible under the scheme.
- An applicant shall submit separate applications for each Target Segment products.
- An applicant making multiple applications for the same product covered under the target segment shall **not** be eligible.
- The qualification of applicants shall be decided on consolidated global Electronics System Design and Manufacturing (ESDM) revenue or manufacturing revenue/technological and financial capability and shall be detailed in the scheme guidelines.

BASE YEAR Financial Year (FY) 2024-25 shall be treated as the base year for the computation of turnover linked incentive under the scheme. The applicant may opt for a gestation period of one year and, in such cases, base year would be FY 2025-26.

Incentives – Offered



No.	Target segments	Cumulative investment (₹)	Turnover linked incentive (%)	Capex incentive (%)	
Α		Sub-assemblies (70)			
1	Display module sub- assembly	250 crore	4/4/3/2/2/1	NA	
2	Camera module sub- assembly	250 crore	5/4/4/3/2/2	NA	
В		Bare com	ponents		
3	Non-SMD passive components	50 crore	8/7/7/6/5/4	NA	
4	Electro-mechanicals	50 crore	8/7/7/6/5/4	NA	
5	Multi-layer PCB	50 crore	≤ 6 layers 6/6/5/5/4/4	NA	
			≥ 8 layers 10/8/7/6/5/5		
6	Li-ion Cells for digital application (excluding storage and mobility)	500 crore	6/6/5/5/4/4	NA	
7	Enclosures for Mobile, IT Hardware products and related devices	500 crore	7/6/5/4/4/3	NA	
С		Selected bare components			
8	HDI/MSAP/Flexible PCB	1000 crore	8/7/7/6/5/4	25%	
9	SMD passive components	250 crore	5/5/4/4/3/3	25%	

S.No.	Target segments	Minimum investment	Turnover linked incentive	Capex incentive
		(₹)	(%)	(%)
D	Supply chain	ecosystem an	d Capital equ	ipment
10	Supply chain of sub- assemblies(A) & bare components (B) &(C)	10 crore	NA	25%
11	Capital goods used in electronics manufacturing including their sub- assemblies and components	10 crore	NA	25%

Application Window: Scheme shall be open to receive application from 1 May 2025 through the online portal (www.ecms.meity.gov.in).

For target segment (A), (B) & (C): 3 months For target segment (D): 2 years

Annexure: Annexure A(III) - Threshold criteria for target segments



Target segments	Year	Cumulative incremental investment threshold (in ₹ Cr)	Incremental sales threshold (in ₹ Cr)	Cumulative incremental employment threshold (in No.)
	Year 1	50	200	50
(1) - Display	Year 2	100	400	100
module	Year 3	150	600	150
	Year 4	200	800	200
	Year 5	250	1,000	250
	Year 6	-	1,200	300
	Year 1	50	150	75
(2) Comoro	Year 2	100	300	150
(2) - Camera module	Year 3	150	450	225
	Year 4	200	600	300
	Year 5	250	750	375
	Year 6	-	900	450
	Year 1	10	15	30
(2 9 4) Non CMD	Year 2	20	30	60
(3 & 4)- Non- SMD · Passive & Electro-	Year 3	30	45	90
mechanical	Year 4	40	60	120
	Year 5	50	75	150
	Year 6	-	90	180
	Year 1	10	15	15
	Year 2	20	30	30
(5) - Multilayer PCB	Year 3	30	45	45
(= , = :::::::::::::::::::::::::::::::::	Year 4	40	60	60
	Year 5	50	75	75
	Year 6	-	90	90

Target segments	Year	Cumulative incremental investment threshold (in ₹ Cr)	Incremental sales threshold (in ₹ Cr)	Cumulative incremental employment threshold (in No.)
	Year 1	100	200	100
(6) - Li-ion cells for	Year 2	200	400	200
digital applications	Year 3	300	600	300
(except storage and	Year 4	400	800	400
mobility)	Year 5	500	1,000	500
	Year 6	-	1,200	600
	Year 1	100	200	120
(7) - Enclosures for	Year 2	200	400	240
Mobile, IT	Year 3	300	600	360
Hardware products and	Year 4	400	800	480
related devices	Year 5	500	1,000	600
	Year 6	-	1,200	720
	Year 1	200	200	200
	Year 2	400	400	400
(8) - HDI/MSAP/	Year 3	600	600	600
Flexible PCB	Year 4	800	800	800
	Year 5	1,000	1,000	1,000
	Year 6	-	1,200	1,200
	Year 1	50	75	100
	Year 2	100	150	200
(9) - SMD passive	Year 3	150	225	300
components	Year 4	200	300	400
	Year 5	250	375	500
	Year 6	-	450	600
(10) - Supply chain of sub-assemblies & bare components	-	10	Commencement of commercial production	10*
(11) - Capital goods used in electronics manufacturing including their sub-assemblies and	-	10	Commencement of commercial production	20*
components				

Annexure: List of products covered under certain target segments



<u>S. No.</u>	<u>Target Segments</u>	Products covered
1	Non-SMD passive components	Resistors, Capacitors, Ferrites, Specialty Ceramics, Inductors, Coils (including inductive coil), etc. for electronic applications
2	Electro-mechanicals	Speakers & Microphones for ICT products, Relays, Switches, Connectors, Heat Sinks, Antenna, Vibrator Motors, Oscillators, Filters, Actuators, Crystals, Sensors (non-semiconductor), Transducers, etc. for electronic applications
3	Supply Chain of sub-assemblies & bare components	Laminate, Pre-Peg, Copper Foil, Separator, Cathode Material, Anode Material, Electrolyte, Polypropylene Film, Spray Wire, Lenses, Protective Film, Glass Cover, Back Light, Contrast Film, Polarizer Film, etc. for electronic applications. (This is an illustrative list and is not an exhaustive list of supply chain.)

THE POWER OF BEING UNDERSTOOD

RSM

For further information please contact:

RSM Astute Consulting Pvt. Ltd.

8th Floor, Bakhtawar, 229, Nariman Point, Mumbai - 400 021.

T: (91-22) 6108 5555 / 6121 4444

F: (91-22) 2287 5771 E: emails@rsmindia.in

W: www.rsmindia.in

Offices: Mumbai, New Delhi - NCR, Chennai, Kolkata, Bengaluru, Surat, Hyderabad, Ahmedabad, Pune, Gandhidham, Jaipur, Navi Mumbai and Vijayanagar.



facebook.com/RSMinIndia



twitter.com/RSM_India



linkedin.com/company/rsm-india



youtube.com/@RSMIndia

RSM Astute Consulting Pvt. Ltd. (Including its affiliates) is a member of the RSM network and trades as RSM. RSM is the trading name used by the members of the RSM network.

Each member of the RSM network is an independent accounting and consulting firm each of which practices in its own right. The RSM network is not itself a separate legal entity of any description in any jurisdiction.

The RSM network is administered by RSM International Limited, a company registered in England and Wales (company number 4040598) whose registered office is at 50 Cannon Street, London EC4N 6JJ.

The brand and trademark RSM and other intellectual property rights used by members of the network are owned by RSM International Association, an association governed by article 60 et seg of the Civil Code of Switzerland whose seat is in Zug.

This publication is general in nature. In this publication, we have endeavoured to highlight certain significant aspects of the Electronic Component Manufacturing Scheme, It may be noted that nothing contained in this publication should be regarded as our opinion and facts of each case will need to be analyzed to ascertain applicability or otherwise of the topics covered in this publication. Appropriate professional advice should be sought for applicability of legal provisions based on specific facts. We are not responsible for any liability arising from any statements or errors contained in this publication.

This Publication is protected under Copyright and Intellectual property laws and regulations.

May 2025

© RSM International Association, 2025